



BAV116W

SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe; (Lead-Free Plating). Solderable per MIL-STD-202, Method 208@3
- Polarity: Cathode Band
- Weight: 0.01 grams (Approximate)



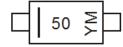
Ordering Information (Note 4)

Part Number	Case	Packaging		
BAV116W-7-F	SOD-123	3,000/Tape & Reel		
BAV116W-13-F	SOD-123	10,000/Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



50 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016)M = Month (ex: 9 = September)

Date Code Key

Year	2000	2001	2002	2003		2015	2016	201	7 2018	2019	2020	2021	2022
Code	L	М	N	Р		С	D	Е	F	G	Н	I	J
Month	Jan	Feb	Mar	Apr	Ma	y J	ın	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	(6	7	8	9	0	N	D

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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _R WM V _R	130	V
RMS Reverse Voltage		V _{R(RMS)}	90	V
Forward Continuous Current		I _{FM}	215	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А

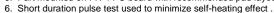
Thermal Characteristics

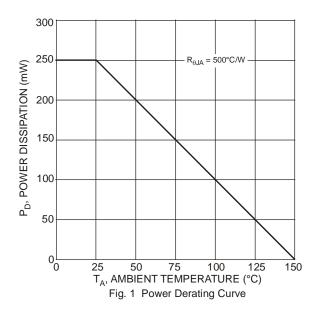
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

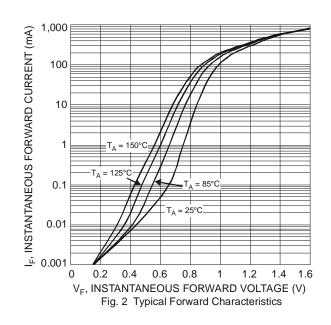
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	130 130	_	_	V	$I_R = 100\mu A$ $I_R = 100\mu A, T_J = 125^{\circ}C$
Forward Voltage	VF	_	_	0.90 1.0 1.1 1.25 1.0	V	I _F = 1.0mA, T _J = 25°C I _F = 10mA, T _J = 25°C I _F = 50mA, T _J = 25°C I _F = 150mA, T _J = 25°C I _F = 10mA, T _J = 125°C
Leakage Current (Note 6)	I _R		_	5.0 80	nA nA	V _R = 75V, T _J = 25°C V _R = 75V, T _J = 125°C
Total Capacitance	Ст		2.4	5	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	_	3.0	μs	$\begin{aligned} I_F &= I_R = 10 \text{mA}, \\ I_{rr} &= 0.1 \times I_R, \ R_L = 100 \Omega \end{aligned}$

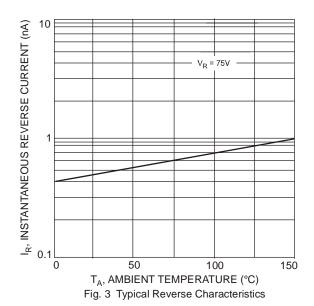
Notes: 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.

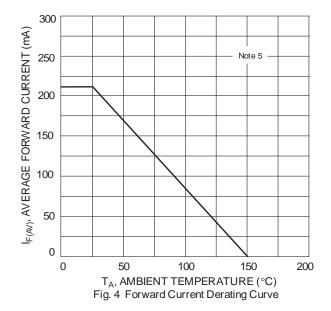






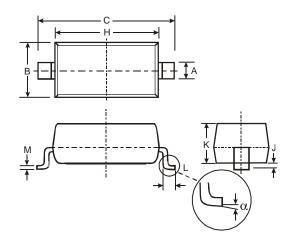






Package Outline Dimensions

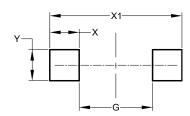
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOD123							
Dim	Min Max						
Α	0.55 Typ						
В	1.40	1.70					
С	3.55	3.85					
Н	2.55	2.85					
J	0.00	0.10					
K	1.00	1.35					
L	0.25	0.40					
М	0.10	0.15					
α	0	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value(in mm)
G	2.250
Х	0.900
X1	4.050
Υ	0.950



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